| Parameter | Rating | Units |
| :--- | :---: | :---: |
| Open Circuit Voltage | 12.2 | V |
| Short Circuit Current | 9.1 | $\mu \mathrm{~A}$ |

## Features

- Dual Independent, Floating Outputs for Parallel, Series, or Isolated Configuration
- 24.4 V Open Circuit Voltage in Series Configuration
- $18.2 \mu \mathrm{~A}$ Short Circuit Current in Parallel Configuration
- 5mA Control Current
- Integrated Turn-Off Circuitry
- High Input to Output Isolation: $3750 \mathrm{~V}_{\text {rms }}$
- Replacement of Discrete Components
- No EMI/RFI Generation
- Surface Mount and Tape \& Reel Version Available
- Flammability Rating UL 94 V-0


## Applications

- MOSFET Driver
- Programmable Control
- Process Control
- Instrumentation
- Telecommunications
- Solid State Relays
- Isolated Switching
- Floating Power Supplies


## Description

The FDA217 is a dual photovoltaic MOSFET driver. Each independent driver consists of an LED that is optically coupled to a photodiode array.

The driver output is controlled by means of the highly effective infrared LED at the input. When the input current is applied to the LED, the light emitted activates the photodiode array, and generates the voltage at the output.

The photodiode array is capable of generating a floating power source with voltage and current sufficient to drive high-power MOSFET transistors. Each photodiode array contains an integrated turn-off circuit that discharges the external MOSFET gate when LED current is removed. This eliminates the need to use external components to facilitate the discharge. The optically coupled technology provides $3750 \mathrm{~V}_{\text {rms }}$ of input to output isolation.

The FDA217 is well suited for use in discrete solid state relay designs and in other isolated switching applications.

## Approvals

- EN 62368-1 Certificate\# B 0826670008


## Ordering Information

| Part \# | Description |
| :--- | :--- |
| FDA217 | 8-Lead DIP (50/tube) |
| FDA217S | 8-Lead Surface Mount (50/tube) |
| FDA217STR | 8-Lead Surface Mount (1000/reel) |

Pin Configuration


ROHS
e3

Absolute Maximum Ratings @ $25^{\circ} \mathrm{C}$

| Parameter | Ratings | Units |
| :--- | :---: | :---: |
| Reverse Input Voltage | 5 | V |
| Input Control Current <br> Peak (10ms) | 50 | mA |
|  | 1 | A |
| Input Power Dissipation $^{1}$ | 140 | mW |
| Total Power Dissipation ${ }^{2}$ | 500 | mW |
| ESD Rating, Human Body Model | 8 | kV |
| Isolation Voltage, Input to Output | 3750 | $\mathrm{~V}_{\text {rms }}$ |
| Operational Temperature | -40 to +85 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature | -40 to +125 | ${ }^{\circ} \mathrm{C}$ |

${ }^{1}$ Derate linearly $1.33 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$
${ }^{2}$ Derate output power linearly $6.67 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Typical values are characteristic of the device at the specified temperatures and are the result of engineering evaluations. They are provided for information purposes only and are not part of the manufacturing testing requirements.

Electrical Characteristics @ $25^{\circ} \mathrm{C}$

| Parameter | Conditions | Symbol | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output Characteristics |  |  |  |  |  |  |
| Open Circuit Voltage | $\mathrm{I}_{\mathrm{F}}=5 \mathrm{~mA}$ | $V_{O C}$ | 10.5 | 11.75 | 15.3 | V |
|  | $\mathrm{I}_{\mathrm{F}}=10 \mathrm{~mA}$ |  | 10.5 | 12.2 | 15.3 |  |
| Short Circuit Current | $\mathrm{I}_{\mathrm{F}}=5 \mathrm{~mA}$ | $I_{S C}$ | 2.5 | 4.5 | - | $\mu \mathrm{A}$ |
|  | $\mathrm{I}_{\mathrm{F}}=10 \mathrm{~mA}$ |  | 5 | 9.1 |  |  |
|  | $\mathrm{I}_{\mathrm{F}}=15 \mathrm{~mA}$ |  | 7.5 | 13.5 |  |  |
|  | $\mathrm{I}_{\mathrm{F}}=20 \mathrm{~mA}$ |  | 10 | 18.5 |  |  |
|  | $\mathrm{I}_{\mathrm{F}}=30 \mathrm{~mA}$ |  | 15 | 27 |  |  |
| Switching Speeds <br> Turn-On <br> Turn-Off | $\mathrm{I}_{\mathrm{F}}=5 \mathrm{~mA}, \mathrm{~V}_{\text {LOAD }}=5 \mathrm{~V}, \mathrm{C}_{\text {LOAD }}=200 \mathrm{pF}$ |  |  |  |  | ms |
|  |  | $\mathrm{t}_{\text {on }}$ | - | - | 2 |  |
|  |  | $\mathrm{t}_{\text {off }}$ | - | - | 0.5 |  |
| Offstate Clamping Resistance | $\mathrm{V}_{\mathrm{L}}=1 \mathrm{~V}$ | $\mathrm{R}_{\mathrm{CL}}$ | 100 | 770 | 3300 | $\Omega$ |
| Input Characteristics |  |  |  |  |  |  |
| LED Current to Activate | $\mathrm{I}_{\mathrm{SC}}=2.5 \mu \mathrm{~A}$ | $I_{F}$ | - | 3.8 | 5 | mA |
| Input Voltage Drop | $\mathrm{I}_{\mathrm{F}}=5 \mathrm{~mA}$ | $V_{F}$ | 0.9 | 1.26 | 1.4 | V |
| Reverse Input Current | $\mathrm{V}_{\mathrm{R}}=5 \mathrm{~V}$ | $I_{R}$ | - | - | 10 | $\mu \mathrm{A}$ |
| Common Characteristics |  |  |  |  |  |  |
| Capacitance, Input to Output | - | $\mathrm{C}_{10}$ | - | 3 | - | pF |

## PERFORMANCE DATA



## Manufacturing Information

## Moisture Sensitivity

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits classifies its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, IPC/JEDEC J-STD-020, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a Moisture Sensitivity Level (MSL) classification as shown below, and should be handled according to the requirements of the latest version of the joint industry standard IPC/JEDEC J-STD-033.

| Device | Moisture Sensitivity Level (MSL) Classification |
| :---: | :---: |
| FDA217S | MSL 1 |

## ESD Sensitivity

This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

## Soldering Profile

Provided in the table below is the IPC/JEDEC J-STD-020 Classification Temperature ( $\mathrm{T}_{\mathrm{C}}$ ) and the maximum dwell time the body temperature of these surface mount devices may be $\left(T_{C}-5\right)^{\circ} \mathrm{C}$ or greater. The Classification Temperature sets the Maximum Body Temperature allowed for these devices during reflow soldering processes.

| Device | Classification Temperature ( $\mathrm{T}_{\mathrm{c}}$ ) | Dwell Time ( $\mathrm{t}_{\mathrm{p}}$ ) | Max Reflow Cycles |
| :---: | :---: | :---: | :---: |
| FDA217S | $250^{\circ} \mathrm{C}$ | 30 seconds | 3 |

For through-hole devices, the wave soldering maximum lead (pin) temperature and the maximum dwell time the leads (pins) are at the peak soldering temperature is given in the table below. Maximum wave soldering parameters are shown below.

| Device | Pin Temperature | Body Temperature | Dwell Time | Wave Cycles |
| :---: | :---: | :---: | :---: | :---: |
| FDA217 | $260^{\circ} \mathrm{C}$ | $250^{\circ} \mathrm{C}$ | 10 seconds | 1 |

## Board Wash

IXYS Integrated Circuits recommends the use of no-clean flux formulations. Board washing to reduce or remove flux residue following the solder reflow process is acceptable provided proper precautions are taken to prevent damage to the device. These precautions include but are not limited to: using a low pressure wash and providing a follow up bake cycle sufficient to remove any moisture trapped within the device due to the washing process. Due to the variability of the wash parameters used to clean the board, determination of the bake temperature and duration necessary to remove the moisture trapped within the package is the responsibility of the user (assembler). Cleaning or drying methods that employ ultrasonic energy may damage the device and should not be used. Additionally, the device must not be exposed to halide flux or solvents.


## Mechanical Dimensions

FDA217

$\frac{\text { Dimensions }}{\mathrm{mm}}$
mm
(inches)

FDA217S


FDA217STR Tape \& Reel


For additional information please visit our website at: https://www.ixysic.com

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